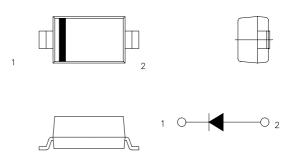
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 $\textbf{FRD} \quad \text{Type} \, : \, EP05FA20$

OUTLINE DRAWING

FEATURES

- * JEDEC SOD-123 Package
- * Ultra-Fast Recovery
- * Very Low Profile 1.1mm Max
- * High Surge Capability
- * Low Thermal Resistance
- * Packaged in 8mm Tape and Reel



Maximum Ratings

Approx Net Weight:0.011g

Rating	Symbol	EP05FA20			Unit	
Repetitive Peak Reverse Voltage	V_{RRM}	200				
Non-repetitive Peak Reverse Voltage	V _{RSM}	220			V	
Average Rectified Output Current	I_{O}	0.45	Ta=25 °C *	50Hz Half Sine	A	
		0.5	Tl=115 °C	Wave Resistive Load		
RMS Forward Current	I _{F(RMS)}	0.785			A	
Surge Forward Current	I _{FSM}	8	50Hz Half Sine Wa	A		
		0	Non-repetitive			
Operating JunctionTemperature Range	T_{jw}	-40 to +150			°C	
Storage Temperature Range	T_{stg}	-40 to +150			$^{\circ}\mathrm{C}$	

Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions		Тур.	Max.	Unit	
Peak Reverse Current	I_{RM}	Tj= 25°C, V _{RM} = V _{RRM}	-	-	10	μΑ	
Peak Forward Voltage	$V_{\rm FM}$	Tj= 25°C, I _{FM} = 1.0A	-	-	0.95	V	
Revere Recovery Time	trr	I _{FM} =1A,-di/dt=50A/μs,Ta=25°C	-	-	30	ns	
Thermal Resistance	Rth _(j-a)	Junction to Ambient *	-	-	300	°C/W	
	Rth _(i-l)	Junction to Lead	-	-	70	C / VV	

^{*} Glass Epoxy Substrate Mounted Soldering Lands=1x1mm,Both Sides

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EP05FA20 OUTLINE DRAWING (Dimensions in mm)

